

MOSFET

OptiMOS[™]5 Power-Transistor, 100 V

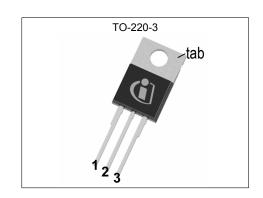
Features

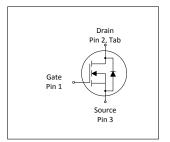
- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



| Parameter | Value | Unit |
|-------------------------|-------|------|
| V _{DS} | 100 | V |
| R _{DS(on),max} | 3.0 | mΩ |
| I_{D} | 120 | A |
| Q _{oss} | 142 | nC |
| Q _G (0V10V) | 112 | nC |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| IPP030N10N5 | PG-TO220-3 | 030N10N5 | - |

OptiMOS[™]5 Power-Transistor, 100 V IPP030N10N5



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OptiMOS[™]5 Power-Transistor, 100 V iPP030N10N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

| Davamatav | Cumb al | | Values | | | Note / Took Condition | |
|--|-----------------------------------|------|--------|------------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current | I _D | - | - | 120 120 | А | T _C =25 °C T _C =100 °C | |
| Pulsed drain current ¹⁾ | I _{D,pulse} | - | - | 480 | Α | T _C =25 °C | |
| Avalanche energy, single pulse ²⁾ | E AS | - | - | 502 | mJ | $I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | P _{tot} | - | - | 250 | W | T _C =25 °C | |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | IEC climatic category; DIN IEC 68-1: 55/175/56 | |

2 Thermal characteristics

Table 3 Thermal characteristics

| Doromotor | Cumbal | Values | | | l lmi4 | Note / Took Condition | |
|--|-------------------|--------|------|------|--------|-----------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | 0.4 | 0.6 | K/W | - | |
| Thermal resistance, junction - ambient, minimal footprint | R _{thJA} | - | - | 62 | K/W | - | |
| Thermal resistance, junction - ambient, 6 cm² cooling area ³⁾ | R _{thJA} | - | - | 40 | K/W | - | |
| Soldering temperature, wave and reflow soldering are allowed | T _{sold} | - | - | 260 | °C | reflow MSL1 | |

See Diagram 3 for more detailed information
 See Diagram 13 for more detailed information
 Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.



3 Electrical characteristics

Table 4 Static characteristics

| D | 0 | | Values | | | |
|----------------------------------|----------------------|------|------------|------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 100 | - | - | V | V _{GS} =0 V, I _D =1 mA |
| Gate threshold voltage | V _{GS(th)} | 2.2 | 3.0 | 3.8 | V | V _{DS} =V _{GS} , I _D =184 μA |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 5 100 | μΑ | V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I _{GSS} | - | 1 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 2.7 3.1 | 3.0 3.8 | mΩ | V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A |
| Gate resistance ¹⁾ | R _G | - | 1.2 | 1.8 | Ω | - |
| Transconductance | g fs | 102 | 203 | - | S | $ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 100 A$ |

Table 5 Dynamic characteristics¹⁾

| Danamatan | C: mah al | | Values | | | |
|------------------------------|------------------|------|--------|-------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance | C _{iss} | - | 7920 | 10300 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz |
| Output capacitance | Coss | - | 1210 | 1570 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 53 | 93 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz |
| Turn-on delay time | $t_{ m d(on)}$ | - | 25 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | t _r | - | 15 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 52 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 17 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω |

Table 6 Gate charge characteristics²⁾

| Parameter | Cumbal | Values | | | l lmi4 | Note / Test Condition |
|------------------------------------|----------------------|--------|------|------|--------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 37 | - | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V |
| Gate to drain charge ¹⁾ | Q_{gd} | - | 23 | 34 | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V |
| Switching charge | Q _{sw} | - | 37 | - | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V |
| Gate charge total ¹⁾ | Qg | - | 112 | 139 | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V |
| Gate plateau voltage | V _{plateau} | - | 4.6 | - | V | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V |
| Output charge ¹⁾ | Qoss | - | 142 | 189 | nC | V _{DD} =50 V, V _{GS} =0 V |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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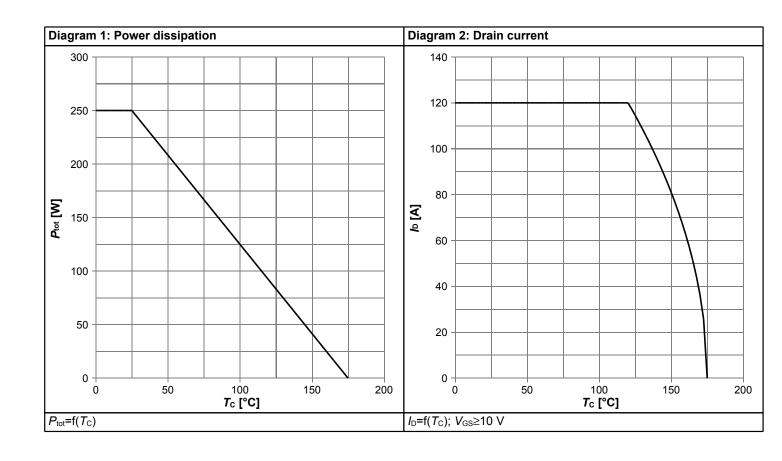


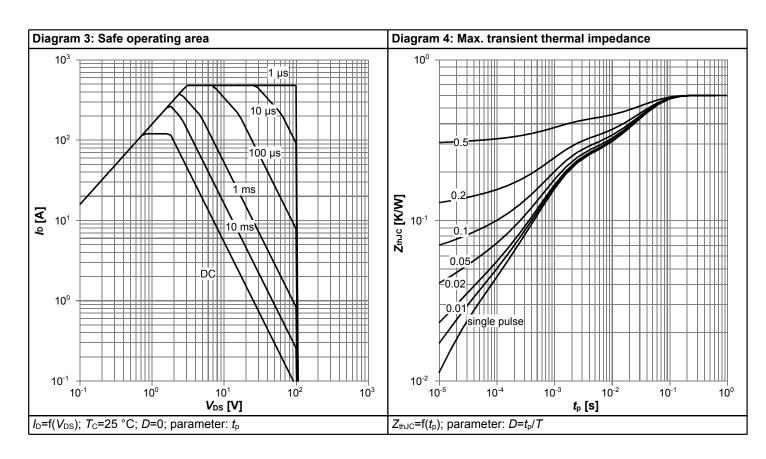
Table 7 Reverse diode

| Dougnatou | Combal | | Values | | | Nata / Tank Oam Pittan | |
|---------------------------------------|----------------------|------|--------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Diode continous forward current | Is | - | - | 120 | Α | T _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 480 | Α | T _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.9 | 1.2 | V | V _{GS} =0 V, I _F =100 A, T _j =25 °C | |
| Reverse recovery time ¹⁾ | t _{rr} | - | 74 | 148 | ns | V_R =50 V, I_F = I_S , di_F/dt =100 A/ μ s | |
| Reverse recovery charge ¹⁾ | Q _{rr} | - | 166 | 332 | nC | V_{R} =50 V, I_{F} = I_{S} , di_{F} / dt =100 A/ μ s | |

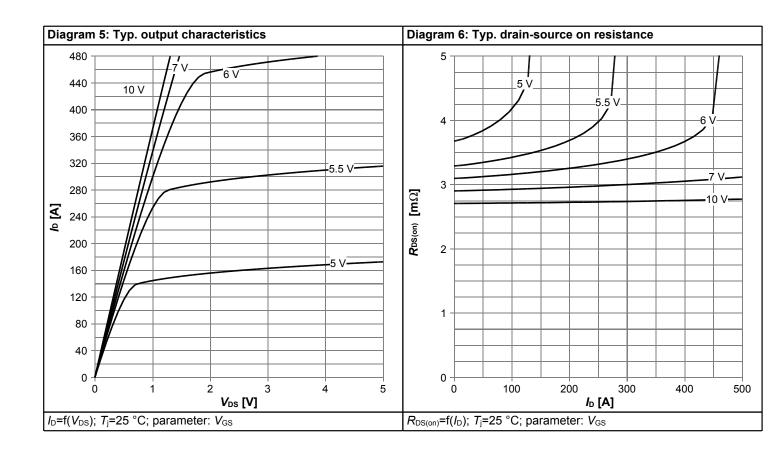


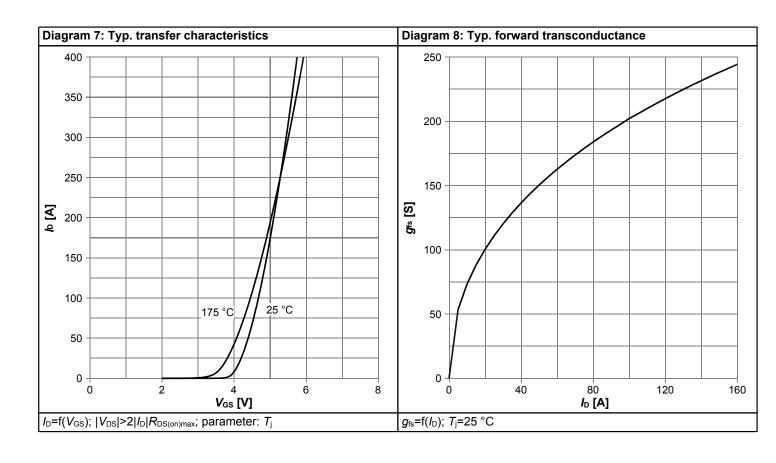
4 Electrical characteristics diagrams



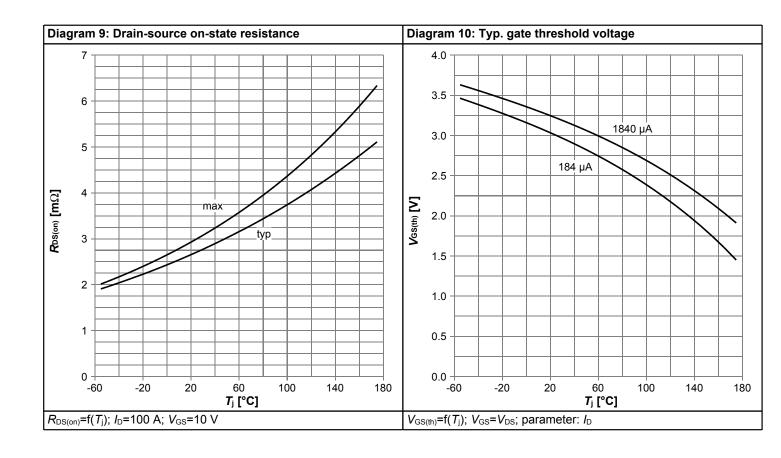


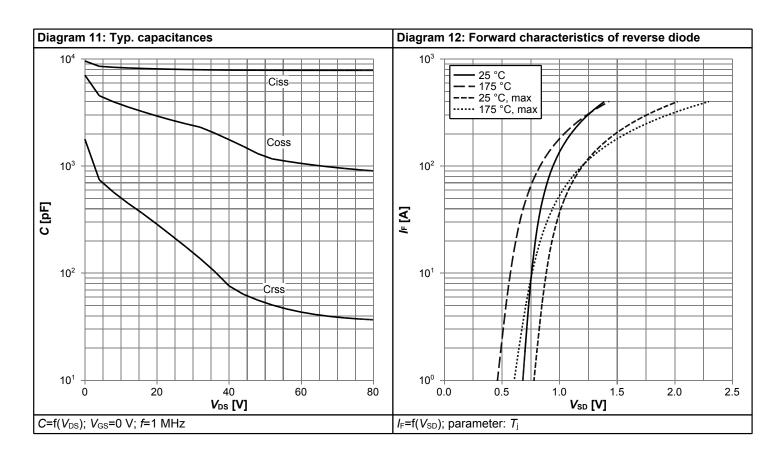




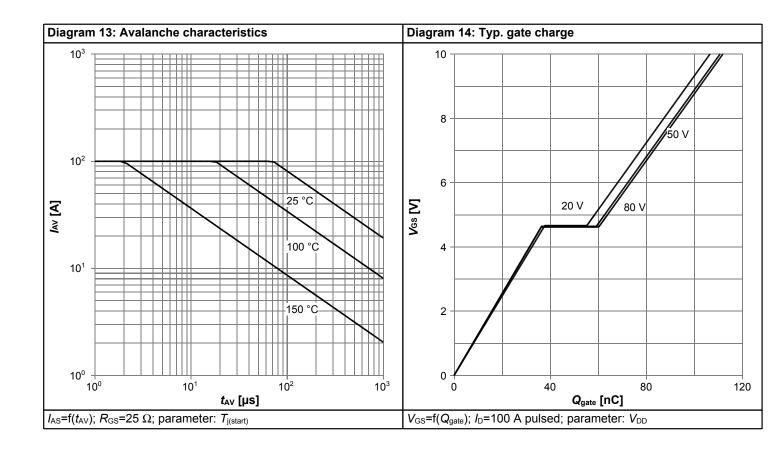


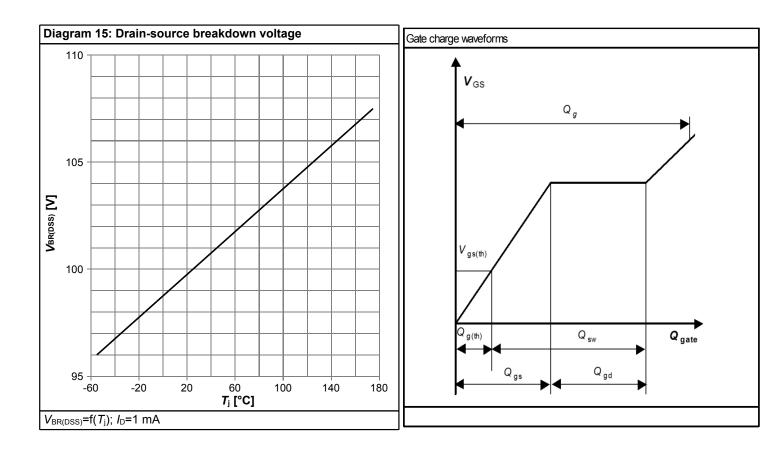






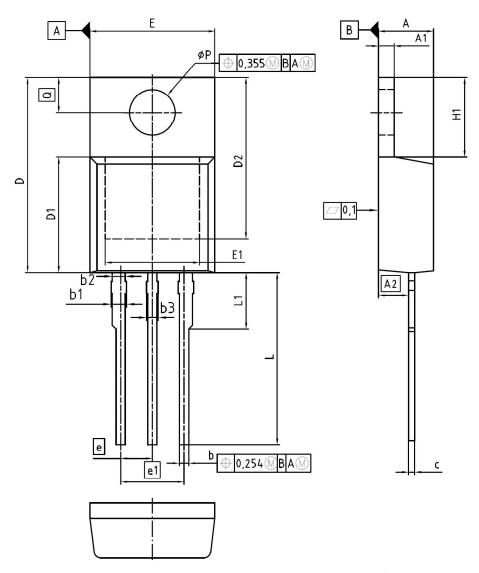








5 Package Outlines



| DIM | MILLIM | ETERS | INCHES | | | | |
|-----|--------|-------|--------|-------|--|--|--|
| DIM | MIN | MAX | MIN | MAX | | | |
| Α | 4.30 | 4.57 | 0.169 | 0.180 | | | |
| A1 | 1.17 | 1.40 | 0.046 | 0.055 | | | |
| A2 | 2.15 | 2.72 | 0.085 | 0.107 | | | |
| b | 0.65 | 0.86 | 0.026 | 0.034 | | | |
| b1 | 0.95 | 1.40 | 0.037 | 0.055 | | | |
| b2 | 0.95 | 1.15 | 0.037 | 0.045 | | | |
| b3 | 0.65 | 1.15 | 0.026 | 0.045 | | | |
| С | 0.33 | 0.60 | 0.013 | 0.024 | | | |
| D | 14.81 | 15.95 | 0.583 | 0.628 | | | |
| D1 | 8.51 | 9.45 | 0.335 | 0.372 | | | |
| D2 | 12.19 | 13.10 | 0.480 | 0.516 | | | |
| E | 9.70 | 10.36 | 0.382 | 0.408 | | | |
| E1 | 6.50 | 8.60 | 0.256 | 0.339 | | | |
| е | 2.5 | 54 | 0.100 | | | | |
| e1 | 5.0 | 08 | 0.2 | :00 | | | |
| N | | 3 | 3 | 3 | | | |
| H1 | 5.90 | 6.90 | 0.232 | 0.272 | | | |
| L | 13.00 | 14.00 | 0.512 | 0.551 | | | |
| L1 | - | 4.80 | - | 0.189 | | | |
| øΡ | 3.60 | 3.89 | 0.142 | 0.153 | | | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | | | |

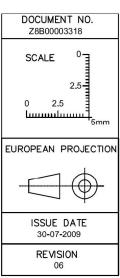


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

OptiMOS[™]5 Power-Transistor, 100 V IPP030N10N5



Revision History

IPP030N10N5

Revision: 2016-10-03, Rev. 2.3

| Previous | Dovicion |
|----------|----------|
| Previous | Revision |

| Trevious revision | | | | | | |
|-------------------|------------|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | |
| 2.0 | 2014-12-17 | Release of final version | | | | |
| 2.1 | 2015-01-30 | Reduction of active area by 0.7% | | | | |
| 2.2 | 2016-07-22 | Update SOA Diagram | | | | |
| 2.3 | 2016-10-03 | Update Avalanche Energy | | | | |

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